

# BUL67

## HIGH VOLTAGE FAST-SWITCHING NPN POWER TRANSISTOR

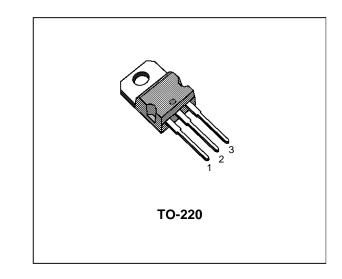
- SGS-THOMSON PREFERRED SALESTYPE
- HIGH VOLTAGE CAPABILITY
- MINIMUM LOT-TO-LOT SPREAD FOR RELIABLE OPERATION
- VERY HIGH SWITCHING SPEED
- FULLY CHARACTERISED AT 125°C

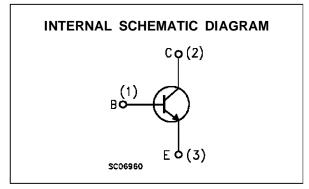
## APPLICATIONS

- ELECTRONICS TRANFORMER FOR HALOGEN LAMPS
- ELECTRONIC BALLASTS FOR FLUORESCENT LIGHTING
- SWITCH MODE POWER SUPPLIES

## DESCRIPTION

The BUL67 is manufactured using high voltage Multiepitaxial Mesa technology for cost-effective high performance. It uses a Hollow Emitter structure to enhance switching speeds. The BUL series is designed for use in lighting applications and in low cost switch-mode power supplies.





Symbol	Parameter	Value	Unit V	
VCES	Collector-Emitter Voltage ( $V_{BE} = 0$ )	700		
V <sub>CEO</sub>	Collector-Emitter Voltage $(I_B = 0)$	400	V	
Vebo	Emitter-Base Voltage ( $I_C = 0$ )99			
Ι <sub>C</sub>	Collector Current	8	A	
Ісм	Collector Peak Current (t <sub>p</sub> < 5 ms)	12	A	
Ι <sub>Β</sub>	Base Current	3.5	A	
I <sub>BM</sub>	Base Peak Current (t <sub>p</sub> < 5 ms)	7	A	
P <sub>tot</sub>	Total Dissipation at $T_c = 25 \ ^{\circ}C$	80	W	
T <sub>stg</sub>	Storage Temperature Range	-65 to 150	°C	
Tj	Max. Operating Junction Temperature	150	°C	

## **ABSOLUTE MAXIMUM RATINGS**

## THERMAL DATA

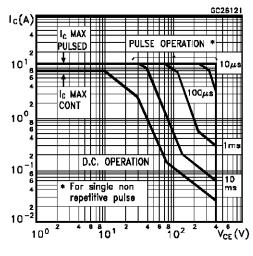
Rthj	-case	Thermal	Resistance	Junction-Case	Max	1.56	°C/W
R <sub>thj</sub>	j-amb	Thermal	Resistance	Junction-Ambient	Max	62.5	°C/W

## **ELECTRICAL CHARACTERISTICS** (T<sub>case</sub> = 25 °C unless otherwise specified)

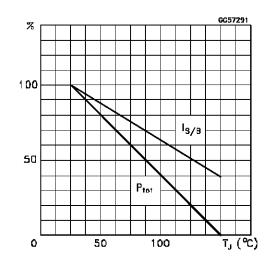
Symbol	Parameter	Test Conditions	Min.	Тур.	Max.	Unit
ICES	Collector Cut-off Current (V <sub>BE</sub> = 0)				100 500	μΑ μΑ
I <sub>CEO</sub>	Collector Cut-off Current ( $I_B = 0$ )	V <sub>CE</sub> = 400 V			250	μA
$V_{CEO(sus)}$	Collector-Emitter Sustaining Voltage	$I_{C} = 100 \text{ mA}$ L = 25 mH	400			V
V <sub>EBO</sub>	Emitter-Base Voltage (I <sub>C</sub> = 0)	$I_E = 10 \text{ mA}$	9			V
V <sub>CE(sat)</sub> *	Collector-Emitter Saturation Voltage				0.8 1 1.5	V V V
V <sub>BE(sat)</sub> *	Base-Emitter Saturation Voltage				1.2 1.3 1.5	V V V
h <sub>FE</sub> *	DC Current Gain	$      I_{C} = 1.5 \text{ A}  V_{CE} = 3 \text{ V} \\       I_{C} = 10 \text{ mA}  V_{CE} = 5 \text{ V} $	15 10		50	
t <sub>s</sub> t <sub>f</sub>	INDUCTIVE LOAD Storage Time Fall Time	$      I_C = 3 A  V_{CL} = 250 V \\       I_{B1} = 0.6 A  I_{B2} = -1.2 A \\       L = 200 \ \mu H $		2.1 100	3.2 180	μs ns
ts t <sub>f</sub>	INDUCTIVE LOAD Storage Time Fall Time	$      I_C = 3 A  V_{CL} = 250 V \\       I_{B1} = 0.6 A  I_{B2} = -1.2 A \\       L = 200 \ \mu H  T_j = 125 \ ^{\circ}C $		3 180		μs ns

\* Pulsed: Pulse duration = 300  $\mu s,$  duty cycle 1.5 %

#### Safe Operating Areas

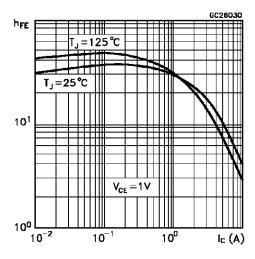


## Derating Curves

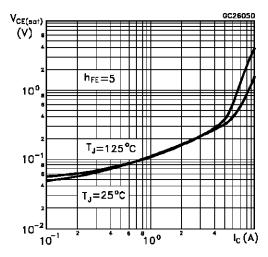




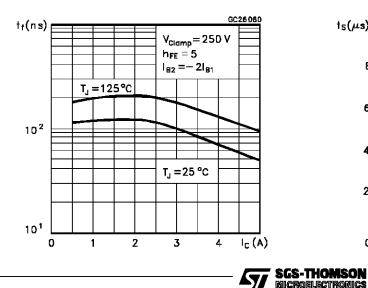
## DC Current Gain



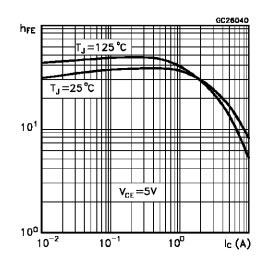
Collector Emitter Saturation Voltage

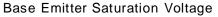


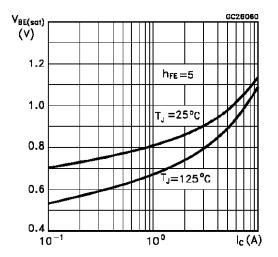
Inductive Fall Time



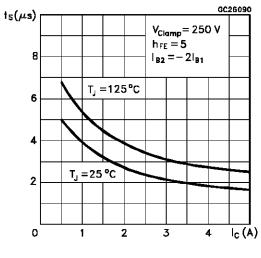
DC Current Gain



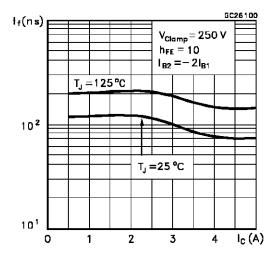




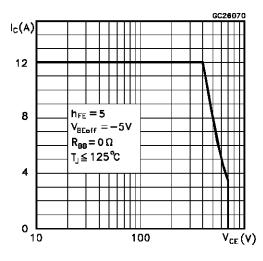
Inductive Storage Time



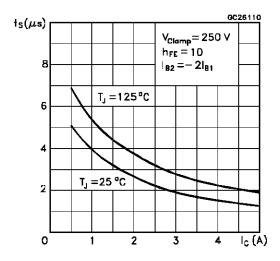
#### Inductive Fall Time



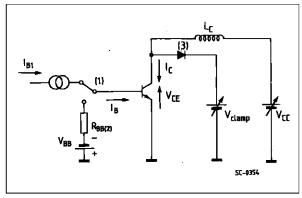
Reverse Biased SOA



Inductive Storage Time



RBSOA and Inductive Load Switching Test Circuit



(1) Fast electronic switch

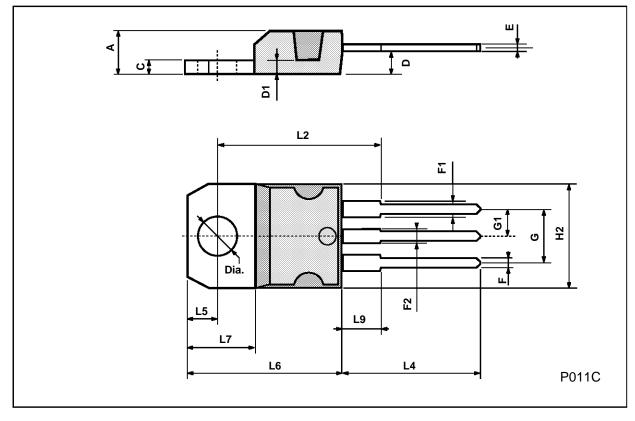
(2) Non-inductive Resistor

(3) Fast recovery rectifier



## TO-220 MECHANICAL DATA

DIM.		mm		inch			
Diwi.	MIN.	TYP.	MAX.	MIN.	TYP.	MAX.	
А	4.40		4.60	0.173		0.181	
С	1.23		1.32	0.048		0.051	
D	2.40		2.72	0.094		0.107	
D1		1.27			0.050		
E	0.49		0.70	0.019		0.027	
F	0.61		0.88	0.024		0.034	
F1	1.14		1.70	0.044		0.067	
F2	1.14		1.70	0.044		0.067	
G	4.95		5.15	0.194		0.203	
G1	2.4		2.7	0.094		0.106	
H2	10.0		10.40	0.393		0.409	
L2		16.4			0.645		
L4	13.0		14.0	0.511		0.551	
L5	2.65		2.95	0.104		0.116	
L6	15.25		15.75	0.600		0.620	
L7	6.2		6.6	0.244		0.260	
L9	3.5		3.93	0.137		0.154	
DIA.	3.75		3.85	0.147		0.151	



Information furnished is believed to be accurate and reliable. However, SGS-THOMSON Microelectronics assumes no responsability for the consequences of use of such information nor for any infringement of patents or other rights of third parties which may results from its use. No license is granted by implication or otherwise under any patent or patent rights of SGS-THOMSON Microelectronics. Specifications mentioned in this publication are subject to change without notice. This publication supersedes and replaces all information previously supplied. SGS-THOMSON Microelectronics or systems without express written approval of SGS-THOMSON Microelectronics.

© 1994 SGS-THOMSON Microelectronics - All Rights Reserved

SGS-THOMSON Microelectronics GROUP OF COMPANIES

Australia - Brazil - France - Germany - Hong Kong - Italy - Japan - Korea - Malaysia - Malta - Morocco - The Netherlands -Singapore - Spain - Sweden - Switzerland - Taiwan - Thailand - United Kingdom - U.S.A

